Intel® 82801GBM I/O Controller

- Essentials		
Status		Launched
Launch Date		Q1'06
Embedded Options Available		Yes
Max TDP		3.3 W
Recommended Customer Price		T&R: \$14.00
Datasheet		Link
- Expansion Options		
PCI Support		6 (32/33)
- I/O Specifications		
USB Revision		USB 2.0
# of USB Ports		8
Total # of SATA Ports		2
Integrated LAN		10/100
Integrated IDE		1 Channel
Package Specifications		
T _{CASE}		99°C-108°C
Package Size		31mm x 31mm
Low Halogen Options Available		See MDDS
Advanced Technologies		
Intel® Virtualization Technology	for Directed I/O (VT-d) ‡	No
Intel® ME Firmware Version		n/a
Intel® Quick Resume Technolog	У	No
Intel® Quiet System Technology	′	No
Intel® HD Audio Technology		Yes
Intel® AC97 Technology		Yes
Intel® Matrix Storage Technolog	39	No
Ordering and Spec Info	rmation	
Frade Compliance Information		
ECCN	CCATS	US HTS

Ordering and Spec Information

Spec Code	Ordering Cod	le Step	RCP
Intel® 82801GBM I/O Controlle	r Hub (ICH7M)		
SL8YB	NH82801GBM	В0	\$14.00

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"Announced" SKUs are not yet available. Please refer to the Launch Date for market availability.

‡ This feature may not be available on all computing systems. Please check with the system vendor to determine if your system delivers this feature, or reference the system specifications (motherboard, processor, chipset, power supply, HDD, graphics controller, memory, BIOS, drivers, virtual machine monitor-VMM, platform software, and/or operating system) for feature compatibility. Functionality, performance, and other benefits of this feature may vary depending on system configuration.

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System and Maximum TDP is based on worst case scenarios. Actual TDP may be lower if not all I/Os for chipsets are used.

Low Halogen: Applies only to brominated and chlorinated flame retardants (BFRs/CFRs) and PVC in the final product. Intel components as well as purchased components on the finished assembly meet JS-709 requirements, and the PCB / substrate meet IEC 61249-2-21 requirements. The replacement of halogenated flame retardants and/or PVC may not be better for the environment.

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